

67-21/G6C-FN2P2B/2T

Features

- P-LCC-2 package.
- White package.
- Optical indicator.
- Colorless clear window.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).
- Pb-free.



• The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the SMT TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.

Device Selection Guide

Chip	Emitted Color	Resin Color	
Material	Emitted Color	Resin Color	
AlGaInP	Brilliant Yellow Green	Water Clear	



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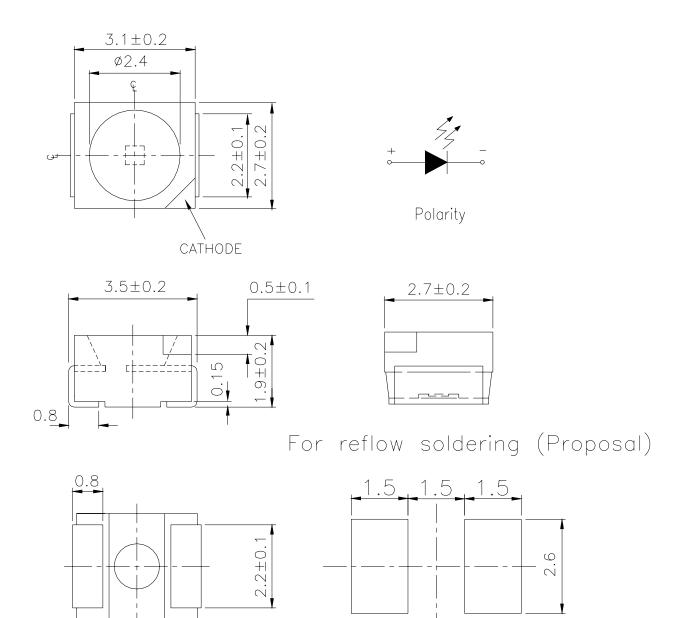
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Package Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter		Rating	Unit
Reverse Voltage		5	V
Forward Current		25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA
Power Dissipation		60	mW
Electrostatic Discharge(HBM)		2000	V
Operating Temperature	Topr	- 40 ∼ +85	$^{\circ}\! \mathbb{C}$
Storage Temperature	Tstg	- 40 ∼ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature		Reflow Soldering : 260 °C Hand Soldering : 350 °C	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	36		72	mcd	
Viewing Angle	2 0 1/2		120		deg	
Peak Wavelength	λр		575		nm	I -20m A
Dominant Wavelength	λd	570		574.5	nm	$I_F=20\text{mA}$
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	V_{F}	1.75		2.35	V	

Notes:

1.Tolerance of Luminous Intensity: ±11%

2. Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ±0.1V

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Bin Range of Luminous Intensity

Bin	Min.	Max.	Unit	Condition
N2	36	45		
P1	45	57	mcd	I _F =20mA
P2	57	72		

Bin Range of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
	CC2	570.0	571.5	nm	I _F =20mA
F	CC3	571.5	573.0		
	CC4	573.0	574.5		

Bin Range of Forward Voltage

Group	Bin	Min.	Max.	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	I _F =20mA
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity: ±11%

2. Tolerance of Dominant Wavelength: ± 1 nm

3. Tolerance of Forward Voltage: $\pm 0.1 V$

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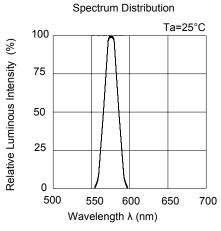


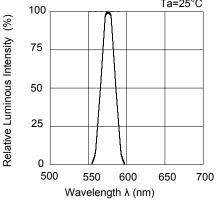
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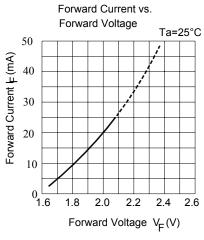
Technical Data Sheet TOP View LEDs

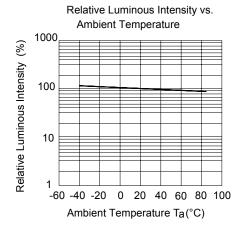
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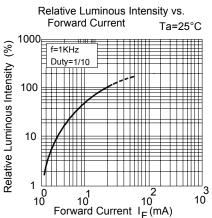
Typical Electro-Optical Characteristics Curves

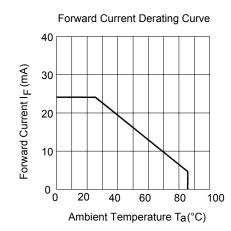


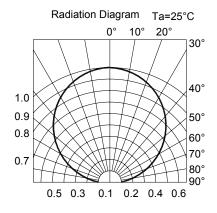












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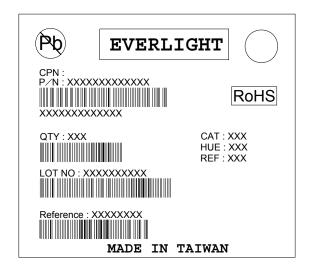
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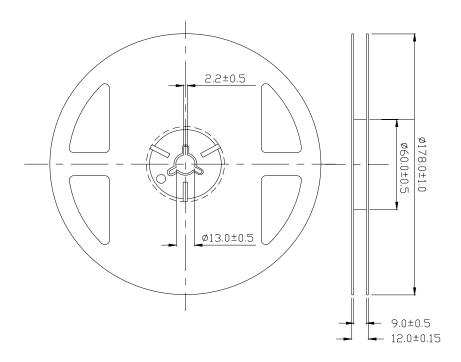
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Label Explanation

CAT: Luminous Intensity Rank HUE: Dom. Wavelength Rank REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

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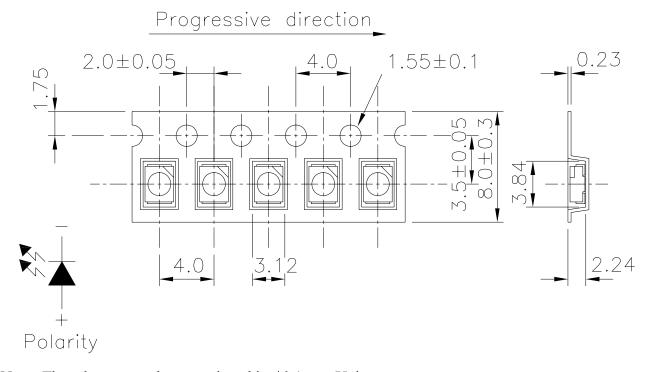
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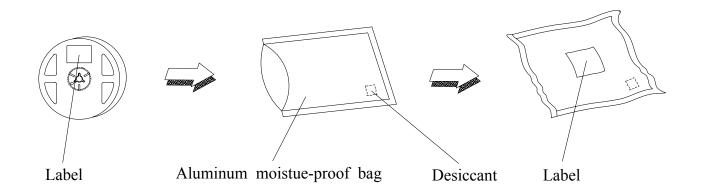
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Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.



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Moisture Resistant Packaging



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Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H:+100°C 15min ∫ 5 min L:-40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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Precautions for Use

1. Over-current-proof

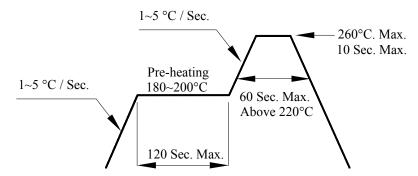
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life are 168 hours under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5℃ for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

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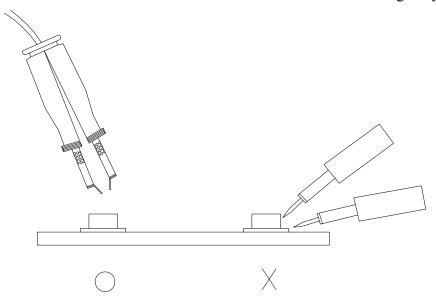
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5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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